

## 8.1: BANDWIDTH OF TEM DIODE LIMITERS

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To date diode limiters are either parametric frequency converting devices<sup>1-6</sup> or simply diodes shunting a transmission line<sup>7-12</sup>. The parametric limiters are narrow band because they must be made using cavities. Future techniques might improve their bandwidth but it is felt that in the limit their bandwidth would approach that of the techniques discussed here. The derivation of the bandwidth of a limiter consisting of diodes shunting a TEM transmission line is similar to the derivation of the bandwidth of a series diode switch<sup>13</sup>. The attenuation  $\alpha$  of an admittance  $G + jB$  shunting a transmission line of characteristic admittance  $Y_0$  is given by the equation

$$\alpha = 10 \log \left[ \left( \frac{G}{2Y_0} + 1 \right)^2 + \left( \frac{B}{2Y_0} \right)^2 \right].$$

The attenuation for various inductances, capacitances, and resistances shunting a 50 ohm transmission line is plotted versus frequency in Figure 1.

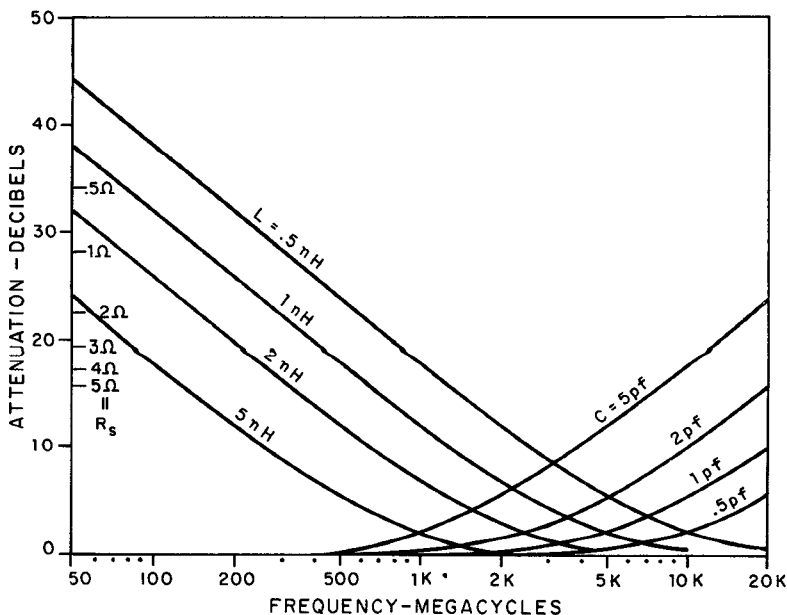


Fig. 1. Attenuation-bandwidth of a diode shunting a 50 ohm transmission line as a function of diode inductance and capacitance. The limit on maximum attenuation imposed by spreading resistance is given along the ordinate.

The capacitive curves in Figure 1, representing the sum of the mount capacitance  $C_M$  and zero bias diode capacitance  $C_O$ , portray the insertion loss bandwidth of a limiter using shunt diodes. The diode spreading resistance  $R_g$  limits the maximum isolation possible with a shunt diode limiter, while the diode "whisker" inductance  $L_w$  limits the isolation bandwidth as portrayed by the inductance curves in Figure 1. If an untuned diode is mounted shunting the TEM transmission line, the isolation and insertion loss will be just as shown in Figure 1. In most applications, however, best results are obtained by tuning the limiter to the design frequency. The maximum isolation is tuned by putting a capacitor in series with the diode and fabricating a very small inductor shunting the diode to complete the d.c. path. The capacitor series-resonates with  $L_w$ , while the inductor parallel-resonates with  $C_O + C_M$  at the design frequency. From Figure 1 it can be seen that a "pill" varactor with  $L_w = 0.7$  nh will provide greater than 20 db isolation over a 600 Mc/s bandwidth. Shunt diode limiters made with varactor diodes can be made to withstand up to 100 watts average incident power and up to 2000 watt-microsecond pulse energy. These limiters are reflective and can be made only for frequencies below the diode self-resonance at which the equivalent circuits mentioned above are valid. In a 50 ohm transmission line, the power output is limited to about 2 mw for germanium, 10 mw for silicon, and 20 mw for gallium arsenide, being a function of the voltage at which the various diodes begin forward conduction.

A matched limiter can be made in a TEM transmission line using the technique developed at X band<sup>14</sup>. When series diodes and matched loads are combined with a 3 db coupler as shown in Figure 2, limiting action results. Assuming the 3 db coupler to be perfect, the attenuation of the device is determined by the reflections from the diode-matched load combination. Two identical diodes of admittance  $G + jB$  in TEM transmission line of characteristic admittance  $Y_O$ , used with a 3 db coupler, will give attenuation  $a$  according to the relationship

$$a = 10 \log \left[ \left( 2 \frac{G}{Y_O} + 1 \right)^2 + \left( 2 \frac{B}{Y_O} \right)^2 \right].$$

The attenuation as a function of diode parameters and frequency is given in Figure 3 for diodes mounted in a 50 ohm transmission line. Again the curves portray the bandwidth if the diodes are tuned. Two MA4254 ( $C_O = 1$  pf) pill varactors were tuned to 1100 Mc/s and mounted in MX24 stripline series "pill" varactor mounts. The diode mounting capacitance  $C_M$  of 1 pf adds to  $C_O$  to give  $C_O + C_M = 2$  pf. The insertion loss for incident power less than 1 mw is less than 1 db from 900 to 1300 Mc/s, the bandwidth of which agrees with Figure 3. The isolation for incident power greater than 5 watts is 25 db which agrees with Figure 3 ( $L_w$  being 0.7 nh). The VSWR of the limiter is less than 1.2 for all incident power levels. The burnout power is calculated to be 20 watts average and 150 watt-microseconds incident pulse energy.

Above 3 Gc/s it becomes increasingly difficult to make limiters

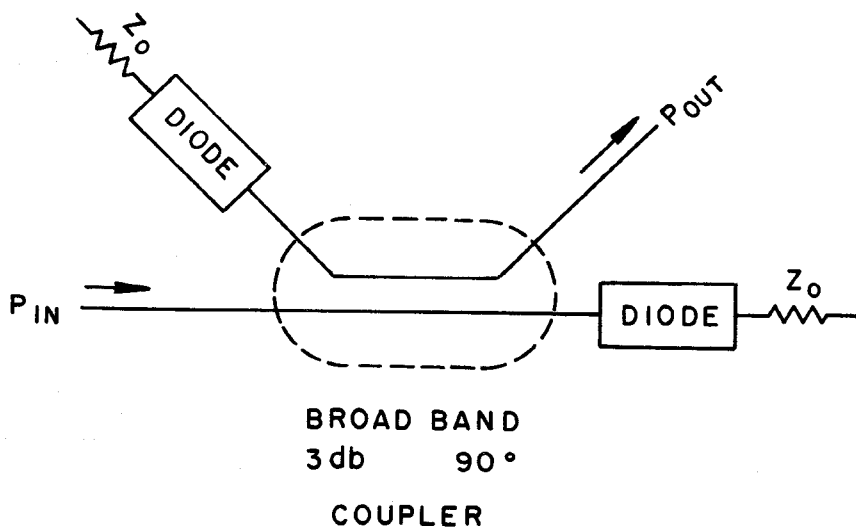


Fig. 2. Schematic diagram of a matched limiter using two diodes with a 3 db coupler.

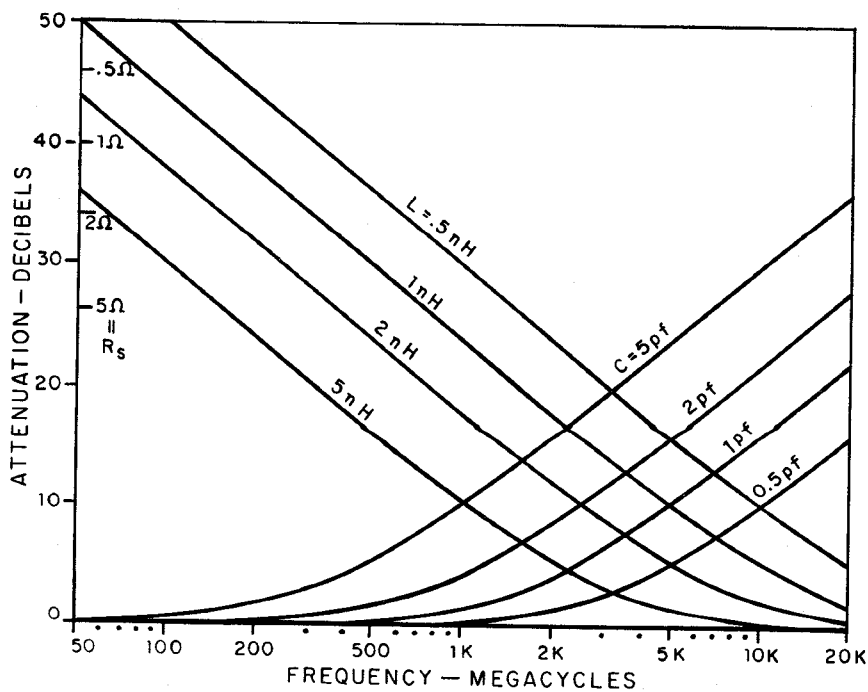


Fig. 3. Attenuation-bandwidth for diodes used with a 3 db coupler as a function of diode inductance and capacitance. The maximum attenuation as a function of spreading resistance is given along the ordinate.

using series diodes with a 3 db coupler. At higher frequencies, the "whisker" inductance  $L_w$  of the diode resonates with the depletion layer capacitance  $C_D$  or the diode cartridge capacitance  $C_c$  and obscures the variation in  $C_D$  with power, this being the basis for limiting. It is necessary at higher frequencies to make use of the diode self-resonance by controlling it. As seen in Figure 4, a diode will limit if  $L_w$

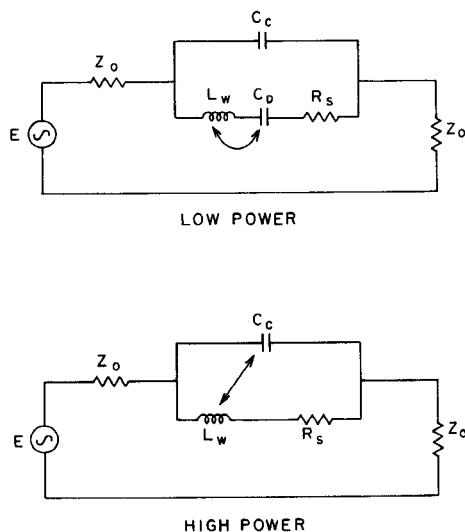


Fig 4. Equivalent circuits of a resonant diode in series in a transmission line. At low power, the series resonance between  $L_w$  and  $C_D$  causes the diode to have a low impedance, thus having a low attenuation. At high power,  $C_D$  is shunted by conduction current, allowing  $L_w$  to parallel-resonate with  $C_c$ . The resulting high impedance of the diode causes high attenuation.

series-resonates with  $C_D$  at low power levels, and parallel-resonates with  $C_c$  at high power levels. The bandwidth of the isolation and insertion loss of this limiter will be dependent on the ratio of the reactance of the whisker inductance  $X_{Res}$  at the resonant frequency to the characteristic impedance  $Z_o$  of the transmission line in which the diode is mounted. The relationship between isolation, insertion loss, bandwidth and  $X_{Res}$  is shown in Figure 5.

The maximum isolation and minimum insertion loss will occur at the resonant frequency  $f$ , and will be limited by the diode cutoff frequency at zero bias  $f_c$ , and  $X_{Res}$  as portrayed in Figure 6.

To illustrate, suppose a limiter is needed at 3 Gc/s with 20 db isolation, less than 1 db insertion loss, and 10 per cent bandwidth. From Figure 5, 20 db isolation and 10 per cent bandwidth give .05 db insertion loss for  $X_{Res} = 2Z_o$ . If we use a varactor diode with  $L_w = 2$  nh, then  $Z_o$  must be 18 ohms, while  $C_D$  at zero bias and  $C_M$  each have to be 1.5 pf. From Figure 6, 20 db isolation and  $X_{Res} = 2Z_o$  gives  $f/f_c = 0.1$

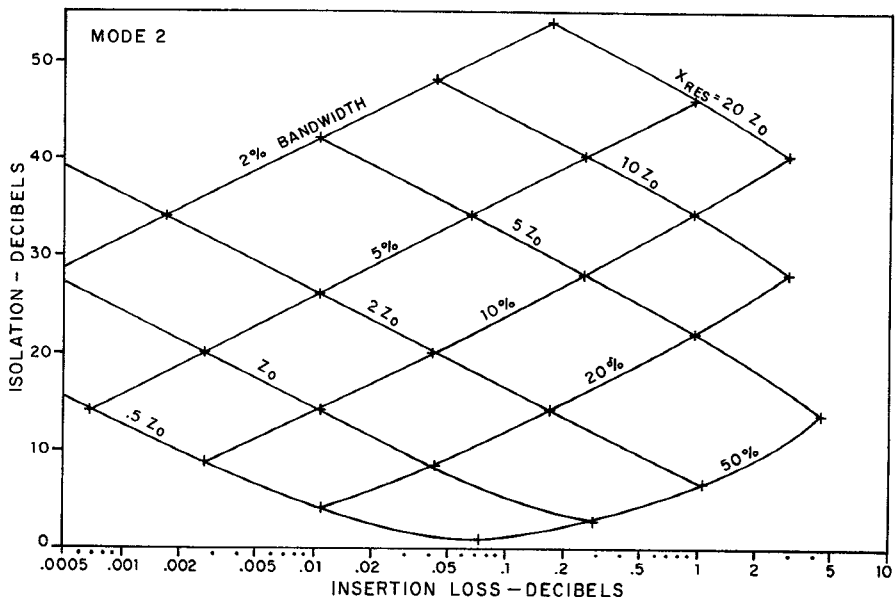


Fig. 5. Minimum isolation and maximum insertion loss of a limiter using a resonant diode in series with the center conductor as a function of bandwidth and  $X_{R_{\omega}}$  (reactance of  $L_{\omega}$  at resonance). These curves also describe the characteristics of a limiter making use of resonant diodes in shunt with a 3 db coupler with  $Z_0$  replaced by  $\frac{Z_0}{4}$ .

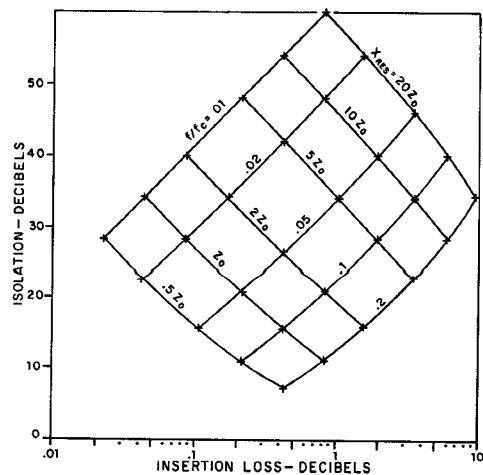


Fig. 6. Maximum isolation and minimum insertion loss of a limiter using a resonant diode in series with the center conductor as a function of  $X_{R_{\omega}}$ , center frequency  $f$ , and zero bias diode cutoff frequency  $f_c = (2\pi R_c C_D)^{-1}$ . These curves also describe the characteristics of a limiter making use of resonant diodes in shunt with a 3 db coupler when  $Z_0$  is replaced by  $\frac{Z_0}{4}$ .

for an insertion loss less than 1 db. Then the cutoff frequency of the diode at zero bias must be 30 Gc/s or about 75 Gc/s at maximum reverse bias.

The limiters described in this paper should exhibit no spike leakage since limiting is caused by diode conduction which for varactors typically begins in less than half of a microwave cycle. The dead time of the limiters will be the same as the recovery time of the varactors, which is typically less than ten nanoseconds.

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1. A. E. Siegman, "Phase-Distortionless Limiting by a Parametric Method," Proc. IRE 47, 447 (1959).
  2. A. E. Siegman & I. T. Ho, "Passive Phase-Distortionless Parametric Limiters," Digest 1961 PGMTT National Symposium, 17-18.
  3. A. A. Wolf & J. E. Pippin, "A Passive Parametric Limiter," Digest of Papers 1960 International Solid State Circuits Conference, 90-91, (1960).
  4. F. A. Olson & G. Wade, "A Cavity-Type Parametric Circuit as a Phase-Distortionless Limiter," Trans. IRE MTT-9, 153-7 (1961).
  5. A. D. Sutherland & D. E. Countiss, "Parametric Phase Distortionless L-Band Limiter," Proc. IRE 48, 938-939 (1960).
  6. F. A. Olson, C. P. Wang, & G. Wade, "Parametric Devices Tested for Phase Distortionless Limiting," Proc. IRE 47, 587-8 (1959).
  7. A. Uhlir, Jr., "Semiconductor Diodes in High-Frequency Communications," Bell Telephone Laboratories Fourth Interim Report on Improved Crystal Rectifiers, Signal Corps Contract DA 36-039-SC-73224, 32-33 (Jan. 1958); also Proc. IRE 46, 1113 (1958).
  8. N. G. Cranna, "Diffused Silicon PIN Diodes as Protective Limiters in Microwave Circuits," Bell Telephone Laboratories Tenth Interim Report on Microwave Solid State Devices, Signal Corps Contract DA 36-039-SC-73224, (Aug. 1959).
  9. D. Leenov, N. G. Cranna & J. H. Forster, "Interim Tests on Silicon PIN Limiter Diodes," Bell Telephone Laboratories Thirteenth Interim Report on Microwave Solid State Devices, Signal Corps Contract DA 36-039-SC-73224, (May 1960).
  10. D. Leenov, "Calculations of Low-Level Performance for PIN Protective Limiter Diodes," Bell Telephone Laboratories Second Interim Report on Microwave Solid State Devices, Signal Corps Contract, DA 36-039-SC-85325, (Nov. 1960).
  11. Ibid, D. Leenov, "PIN Protective Limiter Diodes - Experimental Results."
  12. D. Leenov, J. H. Forster, & N. G. Cranna, "PIN Diodes for Protective Limiter Applications," Digest of Technical Papers, 1961 International Solid State Circuits Conference, 81 (Feb. 1961).
  13. R. V. Garver, "Theory of TEM Diode Switching," Trans. IRE MTT-9, 224-238 (1961).
  14. R. V. Garver & D. Y. Tseng, "X-Band Diode Limiting," Trans. IRE MTT-9, 202 (1961).